## SQS160ELNW

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AUTOMOTIVE

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# Automotive N-Channel 60 V (D-S) 175 °C MOSFET

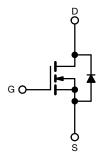


Marking code: Q045

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	60			
$R_{DS(on)}$ ( $\Omega$ ) at $V_{GS}$ = 4.5 V	0.0043			
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.0060			
I <sub>D</sub> (A)	141			
Configuration	Single			
Package	PowerPAK 1212-8SLW			

#### FEATURES

- TrenchFET<sup>®</sup> Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % R<sub>g</sub> and UIS tested
- Wettable flank terminals
- Low thermal resistance with 0.75 mm profile
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \degree C$ , unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	60	V	
Gate-source voltage		V <sub>GS</sub>	± 20	v	
Continuous drain current	T <sub>C</sub> = 25 °C	I	141		
	T <sub>C</sub> = 125 °C	ID	81		
Continuous source current (diode conduction)		I <sub>S</sub>	179	А	
Pulsed drain current <sup>a</sup>		I <sub>DM</sub>	192		
Single pulse avalanche current	L = 0.1 mH	I <sub>AS</sub>	30		
Single pulse avalanche energy		E <sub>AS</sub>	45	mJ	
Maximum power dissipation <sup>a</sup>	T <sub>C</sub> = 25 °C	Р	113	W	
	T <sub>C</sub> = 125 °C	P <sub>D</sub>	66	vv	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	
Soldering recommendations (peak temperat		260	C		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Junction-to-ambient	PCB mount <sup>b</sup>	R <sub>thJA</sub>	81	°C/W		
Junction-to-case (drain)		R <sub>thJC</sub>	0.8	0/10		

#### Notes

- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. When mounted on 1" square PCB (FR4 material)

c. See solder profile (<u>www.vishay.com/doc?73257</u>). A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS}=0,I_D=250\;\mu A$		60	-	-	v	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$		1.5	2.0	2.5	v	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	-	± 100	nA	
		$V_{GS} = 0 V$	V <sub>DS</sub> = 60 V	-	-	1		
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{GS} = 0 V$	$V_{DS} = 60 \text{ V}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	-	50	μA	
		$V_{GS} = 0 V$	V <sub>DS</sub> = 60 V, T <sub>J</sub> = 175 °C	-	-	150		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>GS</sub> = 10 V	$V_{DS} \ge 5 V$	20	-	-	Α	
		V <sub>GS</sub> = 4.5 V		-	0.0046	0.0060	-	
5	_	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 10 A	-	0.0029	0.0043		
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 10 A, T <sub>J</sub> = 125 °C	-	-	0.0095	Ω	
		V <sub>GS</sub> = 10 V	I <sub>D</sub> = 10 A, T <sub>J</sub> = 175 °C	-	-	0.0113	1	
Forward transconductance b	<b>g</b> <sub>fs</sub>	V <sub>DS</sub>	= 15 V, I <sub>D</sub> = 20 A	-	90	-	S	
Dynamic <sup>b</sup>		1			1	<u> </u>		
Input capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V V <sub>DS</sub> = 25 V, f = 1 MHz	-	2761	3866	pF	
Output capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V		-	851	1192		
Reverse transfer capacitance	C <sub>rss</sub>			-	67	94		
Total gate charge <sup>c</sup>	Qg			-	47	71		
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V V <sub>DS</sub> = 30 V, I <sub>D</sub> = 4 A		-	10	-	nC	
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>				8	-		
Gate resistance	R <sub>g</sub>	f = 1 MHz		0.4	0.9	1.4	Ω	
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>	$V_{DD}=30~V,~R_L=12~\Omega, \label{eq:VDD}$ $I_D\cong 2.5~A,~V_{GEN}=10~V,~R_g=1~\Omega$		-	12	18		
Rise time <sup>c</sup>	t <sub>r</sub>			-	4	8	- ns	
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>			-	32	48		
Fall time <sup>c</sup>	t <sub>f</sub>			-	14	21		
Source-Drain Diode Ratings and Charac	teristic <sup>b</sup>	1						
Pulsed current <sup>a</sup>	I <sub>SM</sub>			-	-	192	А	
Forward voltage	V <sub>SD</sub>	I <sub>F</sub> = 10 A, V <sub>GS</sub> = 0 V		-	0.82	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>	V <sub>DD</sub> = 48 V, I <sub>FM</sub> = 3 A, di/dt = 100 A/μs, R = 10 Ω, L = 0.3 mH, pulse width = 2 μs		-	38	76	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>			-	35	70	nC	
Reverse recovery fall time	t <sub>a</sub>			-	19	-		
Reverse recovery rise time	t <sub>b</sub>			-	20	-	ns	
Body diode peak reverse recovery current	I <sub>RM(REC)</sub>			-	-1.6	_	А	

Notes

a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$ 

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

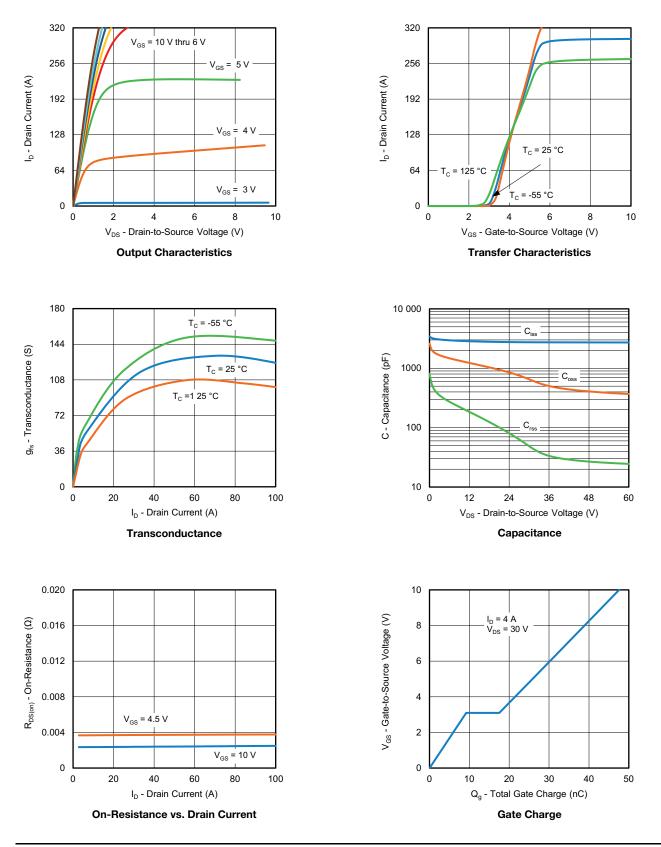
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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### **TYPICAL CHARACTERISTICS** ( $T_A = 25 \text{ °C}$ , unless otherwise noted)



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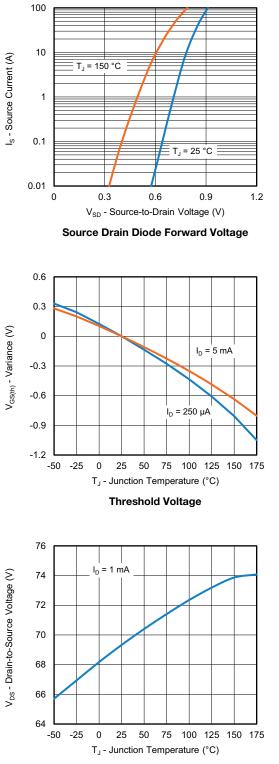
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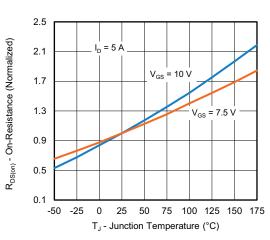
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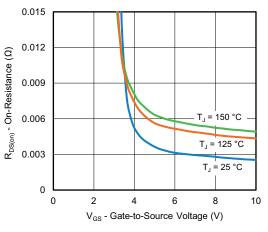
### TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25 °C, unless otherwise noted)



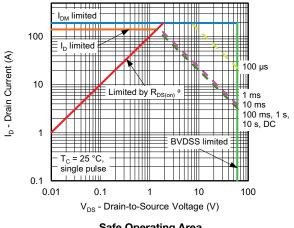
Drain Source Breakdown vs. Junction Temperature



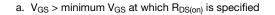
**On-Resistance vs. Junction Temperature** 



**On-Resistance vs. Gate-to-Source Voltage** 



Safe Operating Area



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Note

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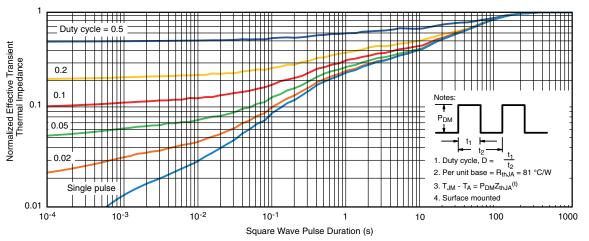
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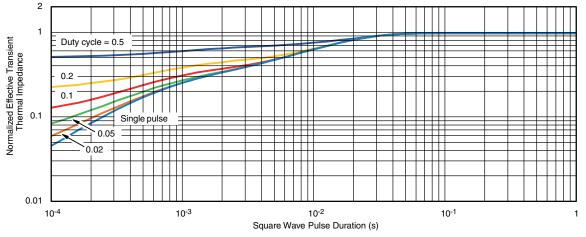


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### **THERMAL RATINGS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

#### Note

- The characteristics shown in the two graphs
  - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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